

### PROTECTION PRODUCTS

#### Description

The LC03-3.3 transient voltage suppressor is designed to protect components which are connected to high speed data and telecommunication lines from voltage surges caused by **lightning**, electrostatic discharge (**ESD**), and electrical fast transients (**EFT**).

TVS diodes are ideal for use as board level protection of sensitive semiconductor components. The LC03-3.3 combines a TVS diode with a rectifier bridge to provide transient protection in both common and differential mode with a single device. The LC03-3.3 utilizes Semtech's EPD technology for superior electrical characteristics at 3.3 volts. The capacitance of the device is minimized to ensure correct signal transmission on high speed lines.

The LC03-3.3 meets the short-haul (intra-building) transient immunity requirements of Bellcore 1089 for telecommunications applications.

#### Features

- ◆ 1800 watts peak pulse power ( $t_p = 8/20\mu s$ )
- ◆ Transient protection for high-speed data lines to **Bellcore 1089 (Intra-Building) 100A (2/10 $\mu s$ )**  
**ITU K.20  $I_{pp} = 40A (5/310\mu s)$**   
**IEC 61000-4-2 (ESD)  $\pm 15kV$  (air),  $\pm 8kV$  (contact)**  
**IEC 61000-4-4 (EFT) 40A (5/50ns)**  
**IEC 61000-4-5 (Lightning) 100A (8/20 $\mu s$ )**
- ◆ Protects two lines in common and differential mode
- ◆ Low capacitance for high-speed interfaces
- ◆ Low operating voltage (3.3V)
- ◆ Low clamping voltage
- ◆ Integrated structure saves board space and increases reliability
- ◆ Solid-state EPD technology

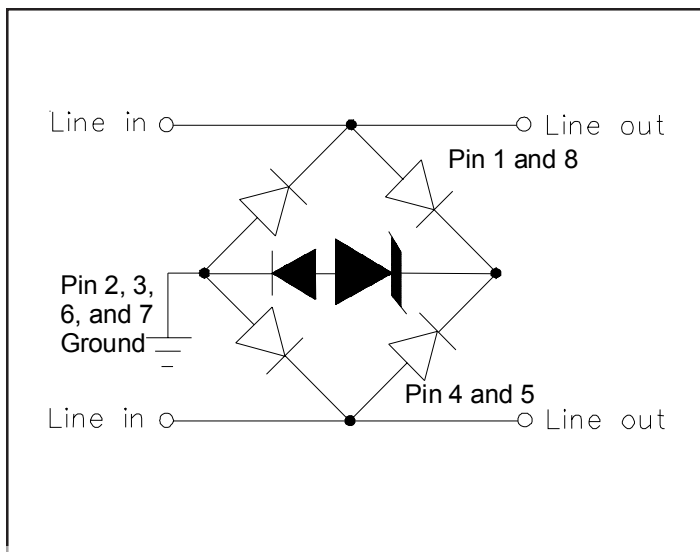
#### Mechanical Characteristics

- ◆ JEDEC SO-8 package
- ◆ Molding compound flammability rating: UL 94V-0
- ◆ Marking : Part number, date code
- ◆ Packaging : Tube or Tape and Reel per EIA 481

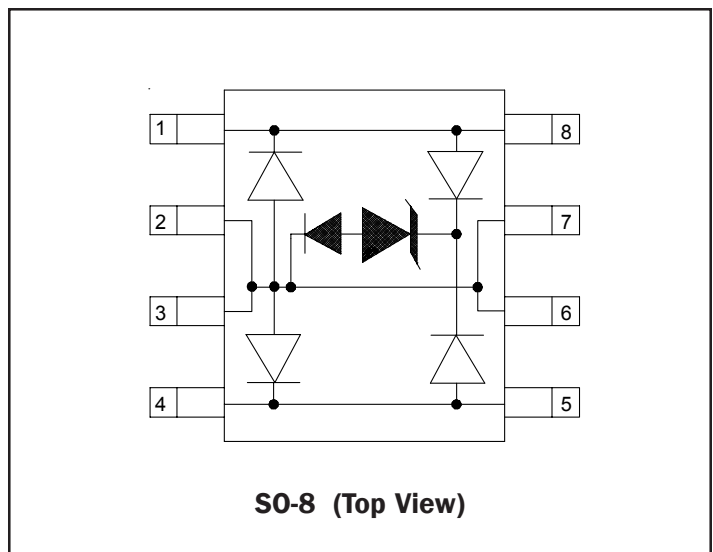
#### Applications

- ◆ Low Voltage Interfaces
- ◆ T3/E3
- ◆ 10/100/1000 Ethernet
- ◆ Set-Top Box
- ◆ ISDN Interfaces

#### Circuit Diagram



#### Schematic & PIN Configuration



**PROTECTION PRODUCTS**
**Absolute Maximum Rating**

Rating	Symbol	Value	Units
Peak Pulse Power ( $t_p = 8/20\mu s$ )	$P_{pk}$	1800	Watts
Peak Pulse Current ( $t_p = 8/20\mu s$ )	$I_{pp}$	100	A
Lead Soldering Temperature	$T_L$	260 (10 sec.)	°C
Operating Temperature	$T_J$	-55 to +125	°C
Storage Temperature	$T_{STG}$	-55 to +150	°C

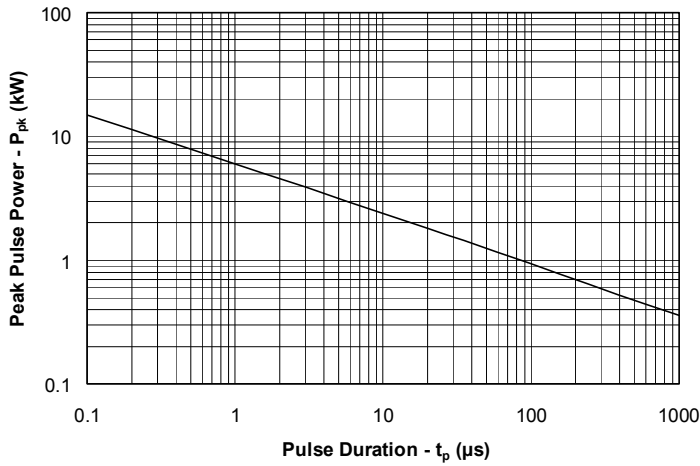
**Electrical Characteristics**

LC03-3.3						
Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	$V_{RWM}$				3.3	V
Punch-Through Voltage	$V_{PT}$	$I_{PT} = 2\mu A$	3.5			V
Snap-Back Voltage	$V_{SB}$	$I_{SB} = 50mA$	2.8			V
Reverse Leakage Current	$I_R$	$V_{RWM} = 3.3V, T=25^\circ C$			1	$\mu A$
Clamping Voltage	$V_C$	$I_{pp} = 50A, t_p = 8/20\mu s$ Line-to-Ground			11.5	V
Clamping Voltage	$V_C$	$I_{pp} = 50A, t_p = 8/20\mu s$ Line-to-Line			13.5	V
Clamping Voltage	$V_C$	$I_{pp} = 100A, t_p = 8/20\mu s$ Line-to-Ground			15	V
Clamping Voltage	$V_C$	$I_{pp} = 100A, t_p = 8/20\mu s$ Line-to-Line			18	V
Junction Capacitance	$C_J$	Between I/O pins and Ground $V_R = 0V, f = 1MHz$		16	25	pF
		Between I/O pins $V_R = 0V, f = 1MHz$		8	12	pF

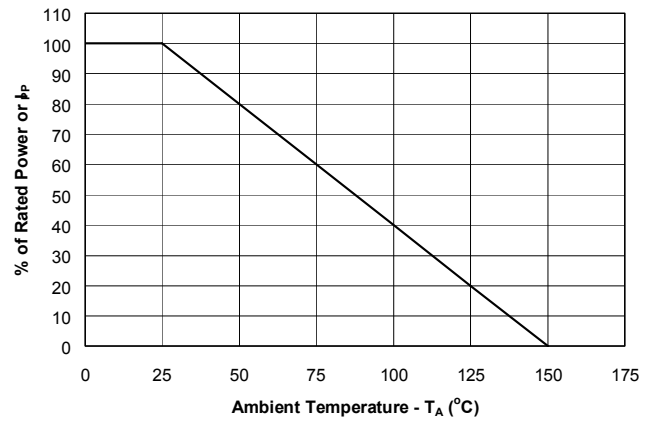
PROTECTION PRODUCTS

Typical Characteristics

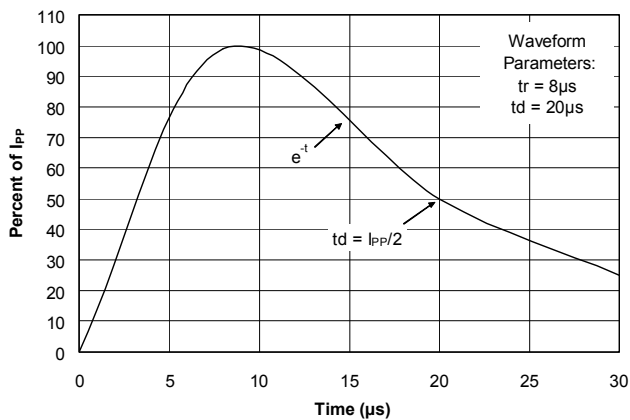
Non-Repetitive Peak Pulse Power vs. Pulse Time



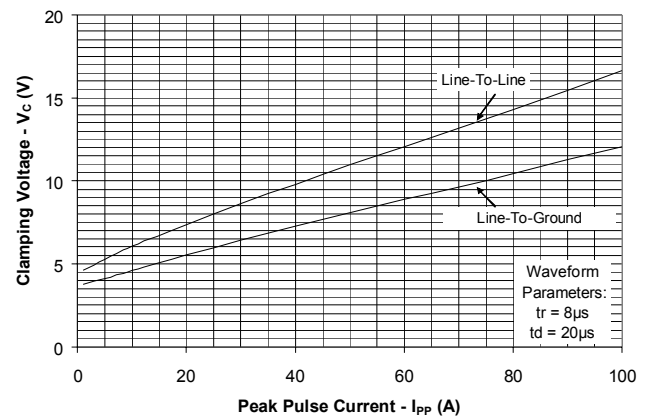
Power Derating Curve



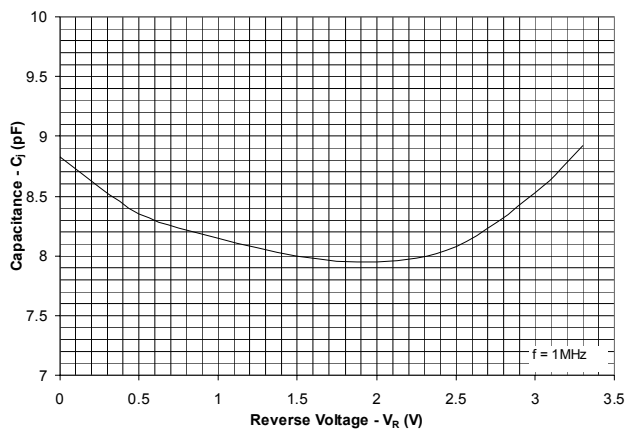
Pulse Waveform



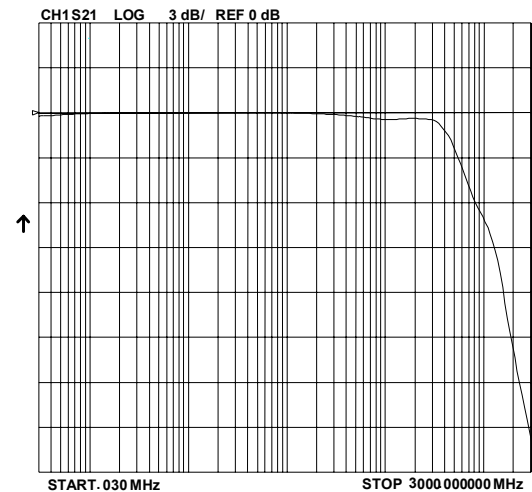
Clamping Voltage vs. Peak Pulse Current



Capacitance vs. Reverse Voltage



Insertion Loss S21 (Line to Ground)



**PROTECTION PRODUCTS**

**Applications Information**

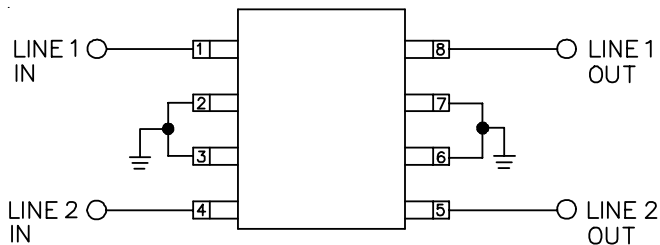
**Device Connection Options for Protection of Two High-Speed Data Lines**

The LC03-3.3 is designed to protect two high-speed data lines (one differential pair) from transient over-voltages which result from lightning and ESD. The device can be configured to protect in differential (Line-to-Line) and common (Line-to-Ground) mode. Data line inputs/outputs are connected at pins 1 to 8, and 4 to 5 as shown. Pins 2, 3, 6, and 7 are connected to ground. These pins should be connected directly to a ground plane on the board for best results. The path length is kept as short as possible to minimize parasitic inductance. In applications where high common mode voltages are present, differential protection is achieved by leaving pins 2, 3, 6, and 7 not connected.

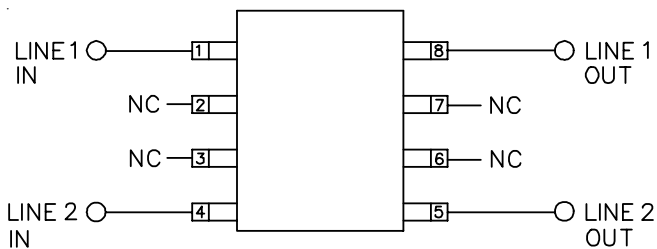
**Matte Tin Lead Finish**

Matte tin has become the industry standard lead-free replacement for SnPb lead finishes. A matte tin finish is composed of 100% tin solder with large grains. Since the solder volume on the leads is small compared to the solder paste volume that is placed on the land pattern of the PCB, the reflow profile will be determined by the requirements of the solder paste. Therefore, these devices are compatible with both lead-free and SnPb assembly techniques. In addition, unlike other lead-free compositions, matte tin does not have any added alloys that can cause degradation of the solder joint.

**Connection for Differential (Line-to-Line) and Common Mode Protection (Line-to-Ground)**

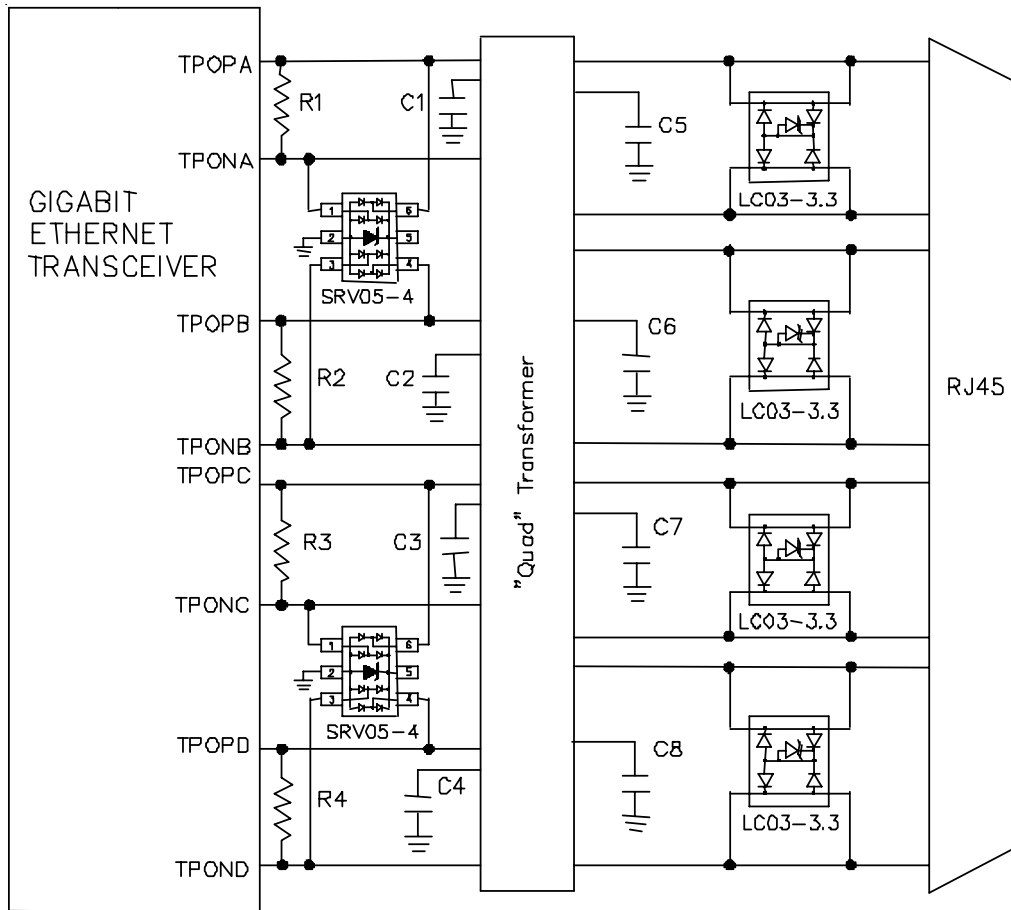


**Connection for Differential Protection (Line-to-Line)**



PROTECTION PRODUCTS

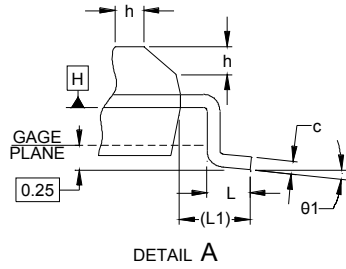
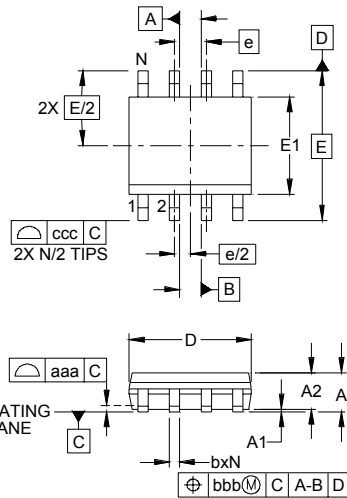
Typical Applications



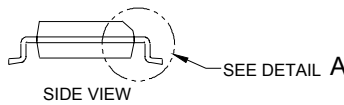
**Bellcore 1089 Intra-Building Protection Gigabit Ethernet**

**PROTECTION PRODUCTS**

**Outline Drawing - SO-8**



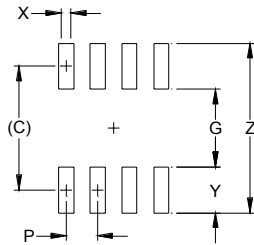
DIM	INCHES			MILLIMETERS		
	MIN	NOM	MAX	MIN	NOM	MAX
A	.053	-	.069	1.35	-	1.75
A1	.004	-	.010	0.10	-	0.25
A2	.049	-	.065	1.25	-	1.65
b	.012	-	.020	0.31	-	0.51
c	.007	-	.010	0.17	-	0.25
D	.189	.193	.197	4.80	4.90	5.00
E1	.150	.154	.157	3.80	3.90	4.00
E	.236 BSC			6.00 BSC		
e	.050 BSC			1.27 BSC		
h	.010	-	.020	0.25	-	0.50
L	.016	.028	.041	0.40	0.72	1.04
L1	(041)			(1.04)		
N	8			8		
$\theta 1$	0°	-	8°	0°	-	8°
aaa	.004			0.10		
bbb	.010			0.25		
ccc	.008			0.20		



NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. DATUMS [A-] AND [B-] TO BE DETERMINED AT DATUM PLANE [H-].
3. DIMENSIONS "E1" AND "D" DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
4. REFERENCE JEDEC STD MS-012, VARIATION AA.

**Land Pattern -SO-8**



DIM	DIMENSIONS	
	INCHES	MILLIMETERS
C	(.205)	(5.20)
G	.118	3.00
P	.050	1.27
X	.024	0.60
Y	.087	2.20
Z	.291	7.40

NOTES:

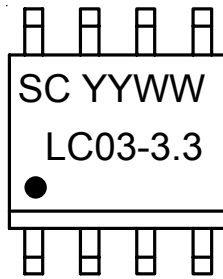
1. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.
2. REFERENCE IPC-SM-782A, RLP NO. 300A.

**PROTECTION PRODUCTS**

**Ordering Information**

Part Number	Lead Finish	Qty per Reel	Reel Size
LC03-3.3.TB	SnPb	500	7 Inch
LC03-3.3.TBT	Pb Free	500	7 Inch

**Marking Diagram**



Note:  
YYWW = Date Code

**Contact Information**

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